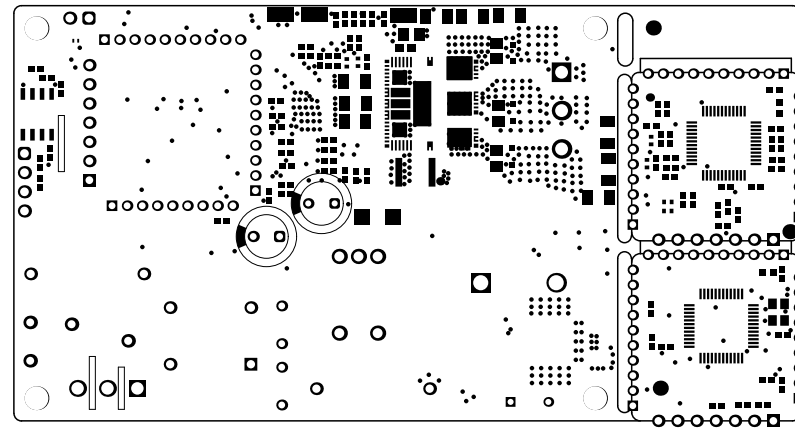
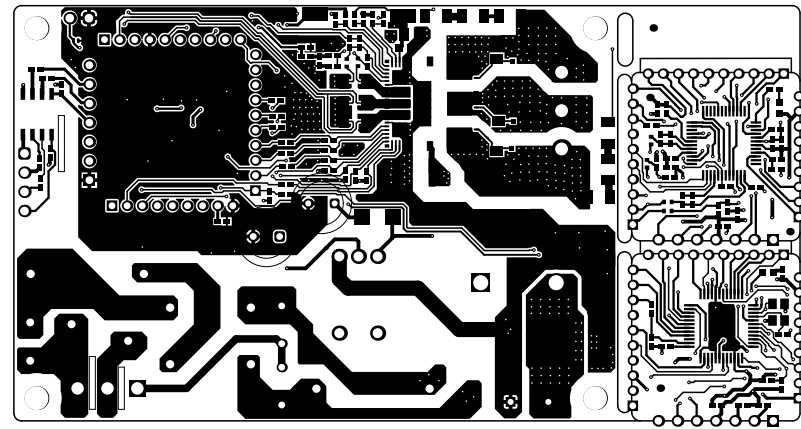


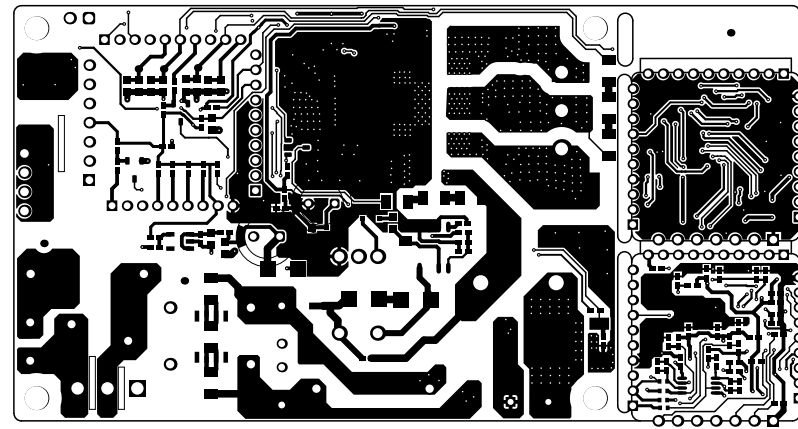
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-010273	REV: E1	SUN REV: Not in version control
LAYER NAME = Top Overlay	TID #: N/A		
PLOT NAME = Top Overlay	GENERATED : 6/2/2024	9:48:16 AM	TEXAS INSTRUMENTS



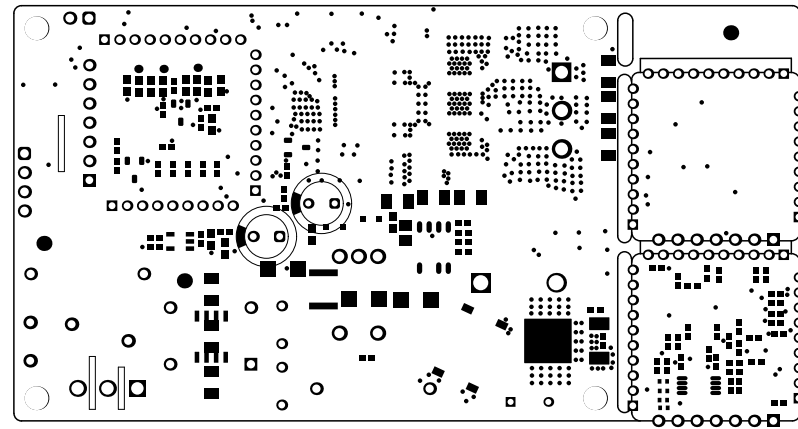
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-010273	REV: E1	SUN REV: Not in version control
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 6/2/2024 9:48:17 AM	TEXAS INSTRUMENTS	



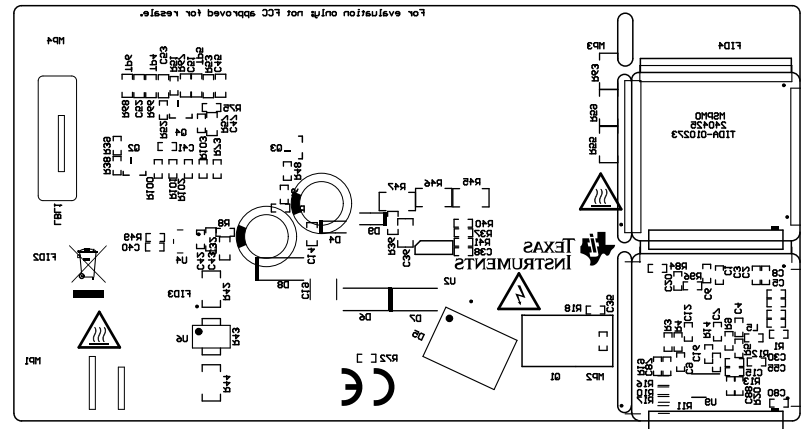
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-010273	REV: E1	SUN REV: Not in version control
LAYER NAME = Top Layer	TID #: N/A		
PLOT NAME = Top Layer	GENERATED : 6/2/2024	9:48:17 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-010273	REV: E1	SUN REV: Not in version control
LAYER NAME = Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 6/2/2024	9:48:18 AM	TEXAS INSTRUMENTS

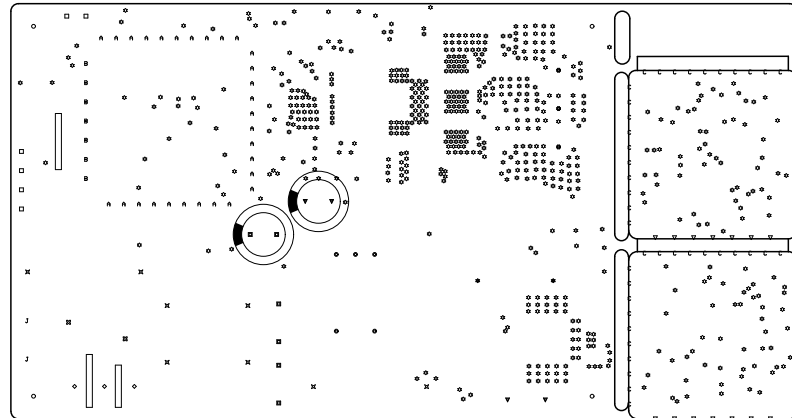


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-010273	REV: E1	SUN REV: Not in version control
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 6/2/2024 9:48:18 AM		TEXAS INSTRUMENTS



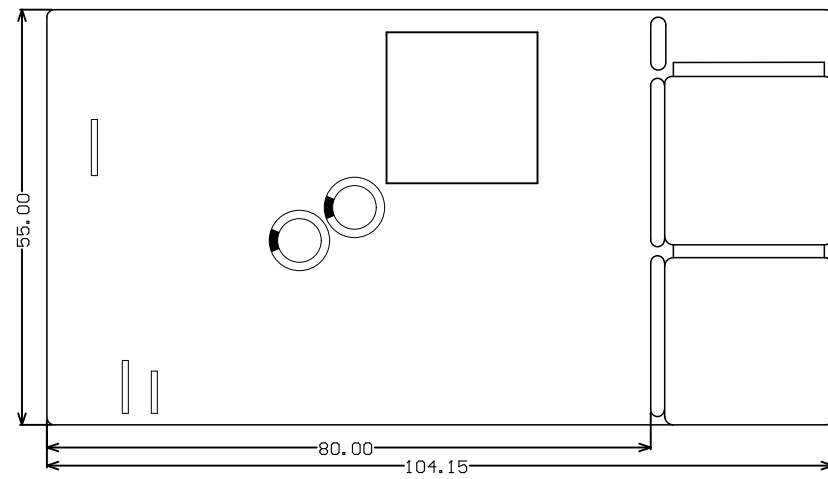
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-010273	REV: E1	SUN REV: Not in version control
LAYER NAME = Bottom Overlay	TID #: N/A		
PLOT NAME = Bottom Overlay	GENERATED : 6/2/2024	9:48:18 AM	TEXAS INSTRUMENTS

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape	Template
☆	617	0.200mm (7.87mil)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	<Mixed>
▽	4	0.800mm (31.50mil)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
C	58	0.890mm (35.04mil)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
▣	6	0.900mm (35.43mil)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
A	29	0.910mm (35.83mil)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
▽	14	1.016mm (40.00mil)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
B	7	1.020mm (40.16mil)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
J	2	1.050mm (41.34mil)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c170h105
⊗	2	1.067mm (42.00mil)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c170h107
⊗	8	1.100mm (43.31mil)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
□	6	1.150mm (45.28mil)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
⊙	5	1.320mm (51.97mil)	PTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c202h132m202p0
◇	3	1.650mm (64.96mil)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
⊕	3	1.700mm (66.93mil)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
★	2	2.000mm (78.74mil)	PTH	Round	Top Layer - Bottom Layer	Pad	<Mixed>	<Mixed>
○	4	3.150mm (124.02mil)	NPTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c315hn315m315p0
	770 Total							



Layer	Name	Material	Thickness
	Top Overlay		
	Top Solder	Solder Resist	0.010mm
1	Top Layer		0.035mm
	Dielectric1	FR4	1.499mm
2	Bottom Layer		0.035mm
	Bottom Solder	Solder Resist	0.010mm
	Bottom Overlay		

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-010273	REV: E1	SUN REV: Not in version control
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 6/2/2024	9:48:19 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-010273	REV: E1	SUN REV: Not in version control
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 6/2/2024	9:48:21 AM	TEXAS INSTRUMENTS

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